

Electronic Patent Application Fee Transmittal

Application Number:	10673686
Filing Date:	29-Sep-2003
Title of Invention:	Mounting spring elements on semiconductor devices, and wafer-level testing methodology
First Named Inventor:	Benjamin N. Eldridge
Filer:	N. Kenneth Burraston/Erin Cowles
Attorney Docket Number:	P7D7C2-US

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
-------------	----------	----------	--------	----------------------

Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790